

ISSUE CLASSIFICATION	
Class	Subclass

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PATENT NUMBER.

U.S. UTILITY Patent Application

<p>O.I.P.E.</p> <p>AC PD Q.A. TC</p> <p>SCANNED</p>	<p>PATENT DATE</p>
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APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/712749		029	830	3728 3725	DAVID TUAN NGUYEN

APPLICANTS

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ABANDONED

• Summary

Low profile integrated module interconnects and method of fabrication

PTO-2040
12/89

ISSUING CLASSIFICATION												
ORIGINAL					CROSS REFERENCE(S)							
CLASS		SUBCLASS			CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)						
INTERNATIONAL CLASSIFICATION												

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<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.				NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____				ISSUE FEE	
				Amount Due	Date Paid
<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.				ISSUE BATCH NUMBER	

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